

# MOTOROLA

## SEMICONDUCTOR TECHNICAL DATA

### 1-to-64 Bit Variable Length Shift Register

The MC14557B is a static clocked serial shift register whose length may be programmed to be any number of bits between 1 and 64. The number of bits selected is equal to the sum of the subscripts of the enabled Length Control inputs (L1, L2, L4, L8, L16, and L32) plus one. Serial data may be selected from the A or B data inputs with the A/B select input. This feature is useful for recirculation purposes. A Clock Enable (CE) input is provided to allow gating of the clock or negative edge clocking capability.

The device can be effectively used for variable digital delay lines or simply to implement odd length shift registers.

- 1–64 Bit Programmable Length
- Q and  $\bar{Q}$  Serial Buffered Outputs
- Asynchronous Master Reset
- All Inputs Buffered
- No Limit On Clock Rise and Fall Times
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Capable of Driving Two Low–power TTL Loads or one Low–power Schottky TTL Load Over the Rated Temperature Range

#### MAXIMUM RATINGS\* (Voltages Referenced to $V_{SS}$ )

Symbol	Parameter	Value	Unit
$V_{DD}$	DC Supply Voltage	– 0.5 to + 18.0	V
$V_{in}, V_{out}$	Input or Output Voltage (DC or Transient)	– 0.5 to $V_{DD} + 0.5$	V
$I_{in}, I_{out}$	Input or Output Current (DC or Transient), per Pin	$\pm 10$	mA
$P_D$	Power Dissipation, per Package†	500	mW
$T_{stg}$	Storage Temperature	– 65 to + 150	°C
$T_L$	Lead Temperature (8–Second Soldering)	260	°C

\* Maximum Ratings are those values beyond which damage to the device may occur.

† Temperature Derating:

Plastic "P and D/DW" Packages: – 7.0 mW/°C From 65°C To 125°C

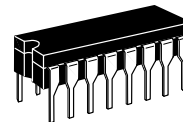
Ceramic "L" Packages: – 12 mW/°C From 100°C To 125°C

#### LENGTH SELECT TRUTH TABLE

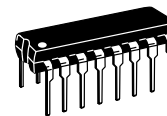
L32	L16	L8	L4	L2	L1	Register Length
0	0	0	0	0	0	1 Bit
0	0	0	0	0	1	2 Bits
0	0	0	0	1	0	3 Bits
0	0	0	0	1	1	4 Bits
0	0	0	1	0	0	5 Bits
0	0	0	1	0	1	6 Bits
⋮	⋮	⋮	⋮	⋮	⋮	⋮
⋮	⋮	⋮	⋮	⋮	⋮	⋮
⋮	⋮	⋮	⋮	⋮	⋮	⋮
1	0	0	0	0	0	33 Bits
1	0	0	0	0	1	34 Bits
⋮	⋮	⋮	⋮	⋮	⋮	⋮
⋮	⋮	⋮	⋮	⋮	⋮	⋮
⋮	⋮	⋮	⋮	⋮	⋮	⋮
1	1	1	1	0	0	61 Bits
1	1	1	1	1	1	62 Bits
1	1	1	1	1	0	63 Bits
1	1	1	1	0	1	64 Bits

NOTE: Length equals the sum of the binary length control subscripts plus one.

## MC14557B



**L SUFFIX**  
CERAMIC  
CASE 620



**P SUFFIX**  
PLASTIC  
CASE 648



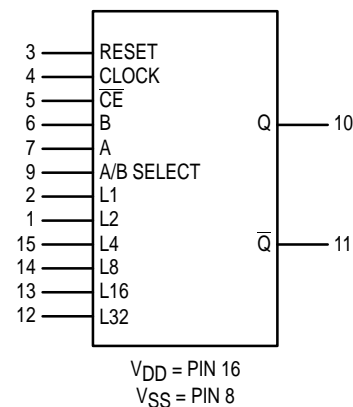
**DW SUFFIX**  
SOIC  
CASE 751G

#### ORDERING INFORMATION

MC14XXXBCP	Plastic
MC14XXXBCL	Ceramic
MC14XXXBDW	SOIC

$T_A = -55^\circ$  to  $125^\circ\text{C}$  for all packages.

#### BLOCK DIAGRAM



#### TRUTH TABLE

Inputs				Output
Rst	A/B	Clock	$\overline{CE}$	Q
0	0	$\nearrow$	0	B
0	1	$\nearrow$	0	A
0	0	1	$\searrow$	B
0	1	1	$\searrow$	A
1	X	X	X	0

Q is the output of the first selected shift register stage.

X = Don't Care



**ELECTRICAL CHARACTERISTICS** (Voltages Referenced to  $V_{SS}$ )

Characteristic	Symbol	$V_{DD}$ Vdc	- 55° C		25° C			125° C		Unit	
			Min	Max	Min	Typ #	Max	Min	Max		
Output Voltage $V_{in} = V_{DD}$ or 0	"0" Level $V_{OL}$	5.0	—	0.05	—	0	0.05	—	0.05	Vdc	
		10	—	0.05	—	0	0.05	—	0.05		
		15	—	0.05	—	0	0.05	—	0.05		
	"1" Level $V_{in} = 0$ or $V_{DD}$	$V_{OH}$	5.0	4.95	—	4.95	5.0	—	4.95		—
			10	9.95	—	9.95	10	—	9.95		—
			15	14.95	—	14.95	15	—	14.95		—
Input Voltage ( $V_O = 4.5$ or $0.5$ Vdc) ( $V_O = 9.0$ or $1.0$ Vdc) ( $V_O = 13.5$ or $1.5$ Vdc)	"0" Level $V_{IL}$	5.0	—	1.5	—	2.25	1.5	—	1.5	Vdc	
		10	—	3.0	—	4.50	3.0	—	3.0		
		15	—	4.0	—	6.75	4.0	—	4.0		
	"1" Level ( $V_O = 0.5$ or $4.5$ Vdc) ( $V_O = 1.0$ or $9.0$ Vdc) ( $V_O = 1.5$ or $13.5$ Vdc)	$V_{IH}$	5.0	3.5	—	3.5	2.75	—	3.5		—
			10	7.0	—	7.0	5.50	—	7.0		—
			15	11	—	11	8.25	—	11		—
Output Drive Current ( $V_{OH} = 2.5$ Vdc) ( $V_{OH} = 4.6$ Vdc) ( $V_{OH} = 9.5$ Vdc) ( $V_{OH} = 13.5$ Vdc)	Source $I_{OH}$	5.0	- 3.0	—	- 2.4	- 4.2	—	- 1.7	—	mAdc	
		5.0	- 0.64	—	- 0.51	- 0.88	—	- 0.36	—		
		10	- 1.6	—	- 1.3	- 2.25	—	- 0.9	—		
		15	- 4.2	—	- 3.4	- 8.8	—	- 2.4	—		
	Sink $I_{OL}$	5.0	0.64	—	0.51	0.88	—	0.36	—		
		10	1.6	—	1.3	2.25	—	0.9	—		
15	4.2	—	3.4	8.8	—	2.4	—	—			
Input Current	$I_{in}$	15	—	$\pm 0.1$	—	$\pm 0.00001$	$\pm 0.1$	—	$\pm 1.0$	$\mu$ Adc	
Input Capacitance ( $V_{in} = 0$ )	$C_{in}$	—	—	—	—	5.0	7.5	—	—	pF	
Quiescent Current (Per Package)	$I_{DD}$	5.0	—	5.0	—	0.010	5.0	—	150	$\mu$ Adc	
		10	—	10	—	0.020	10	—	300		
		15	—	20	—	0.030	20	—	600		
Total Supply Current**† (Dynamic plus Quiescent, Per Package) ( $C_L = 50$ pF on all outputs, all buffers switching)	$I_T$	5.0	$I_T = (1.75 \mu A/kHz) f + I_{DD}$							$\mu$ Adc	
10	$I_T = (3.50 \mu A/kHz) f + I_{DD}$										
15	$I_T = (5.25 \mu A/kHz) f + I_{DD}$										

#Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

\*\*The formulas given are for the typical characteristics only at 25° C.

†To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) Vfk$$

where:  $I_T$  is in  $\mu$ A (per package),  $C_L$  in pF,  $V = (V_{DD} - V_{SS})$  in volts,  $f$  in kHz is input frequency, and  $k = 0.001$ .

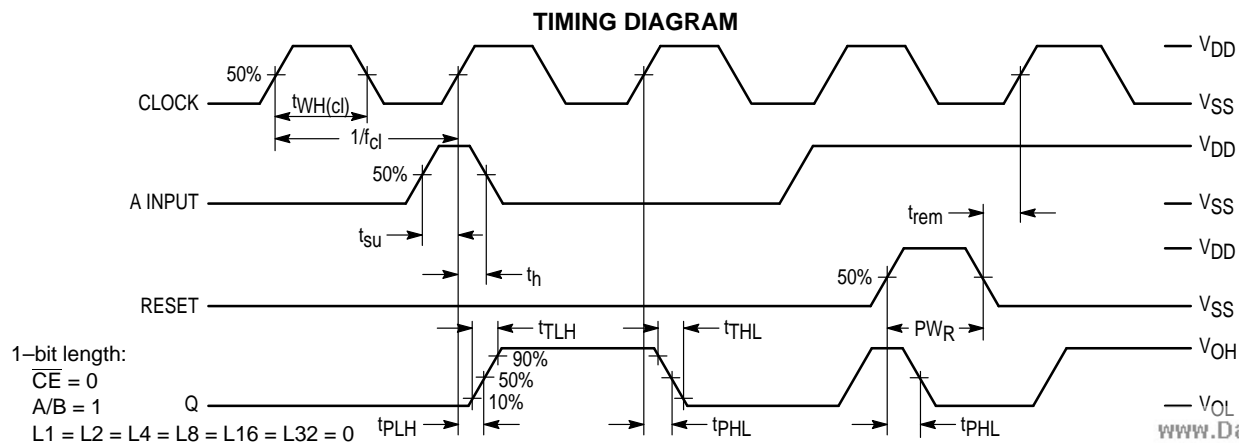
**This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$ . Unused inputs must always be tied to an appropriate logic voltage level (e.g., either  $V_{SS}$  or  $V_{DD}$ ). Unused outputs must be left open.**

**SWITCHING CHARACTERISTICS\*** ( $C_L = 50$  pF,  $T_A = 25^\circ\text{C}$ )

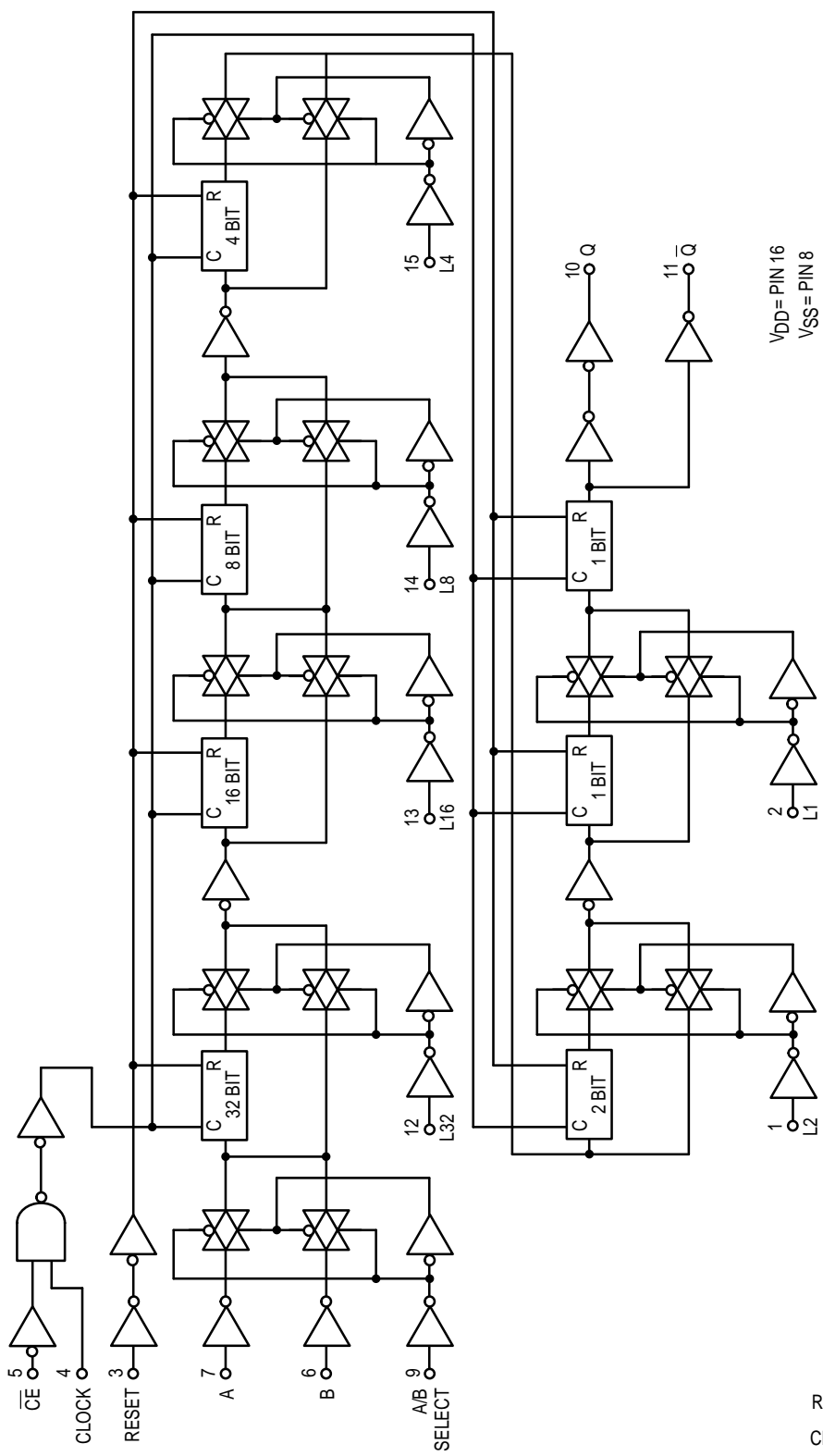
Characteristic	Symbol	V <sub>DD</sub>	Min	Typ #	Max	Unit
Rise and Fall Time, Q or $\bar{Q}$ Output $t_{TLH}, t_{THL} = (1.5 \text{ ns/pF}) C_L + 25 \text{ ns}$ $t_{TLH}, t_{THL} = (0.75 \text{ ns/pF}) C_L + 12.5 \text{ ns}$ $t_{TLH}, t_{THL} = (0.55 \text{ ns/pF}) C_L + 9.5 \text{ ns}$	$t_{TLH}, t_{THL}$	5 10 15	— — —	100 50 40	200 100 80	ns
Propagation Delay, Clock or $\bar{CE}$ to Q or $\bar{Q}$ $t_{PLH}, t_{PHL} = (1.7 \text{ ns/pF}) C_L + 215 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.66 \text{ ns/pF}) C_L + 97 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.5 \text{ ns/pF}) C_L + 65 \text{ ns}$	$t_{PLH}, t_{PHL}$	5 10 15	— — —	300 130 90	600 260 180	ns
Propagation Delay, Reset to Q or $\bar{Q}$ $t_{PLH}, t_{PHL} = (1.7 \text{ ns/pF}) C_L + 215 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.66 \text{ ns/pF}) C_L + 97 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.5 \text{ ns/pF}) C_L + 70 \text{ ns}$	$t_{PLH}, t_{PHL}$	5 10 15	— — —	300 130 95	600 260 190	ns
Pulse Width, Clock	$t_{WH}(cl)$	5 10 15	200 100 75	95 45 35	— — —	ns
Pulse Width, Reset	$t_{WH}(rst)$	5 10 15	300 140 100	150 70 50	— — —	ns
Clock Frequency (50% Duty Cycle)	$f_{cl}$	5 10 15	— — —	3.0 7.5 13.0	1.7 5.0 6.7	MHz
Setup Time, A or B to Clock or $\bar{CE}$ Worst case condition: L1 = L2 = L4 = L8 = L16 = L32 = V <sub>SS</sub> (Register Length = 1)  Best case condition: L32 = V <sub>DD</sub> , L1 through L16 = Don't Care (Any register length from 33 to 64)	$t_{su}$	5 10 15  5 10 15	700 290 145  400 165 60	350 130 85  45 5 0	— — —  — — —	ns
Hold Time, Clock or $\bar{CE}$ to A or B Best case condition: L1 = L2 = L4 = L8 = L16 = L32 = V <sub>SS</sub> (Register Length = 1)  Worst case condition: L32 = V <sub>DD</sub> , L1 through L16 = Don't Care (Any register length from 33 to 64)	$t_h$	5 10 15  5 10 15	200 100 10  400 185 85	-150 -60 -50  50 25 22	— — —  — — —	ns
Rise and Fall Time, Clock	$t_r, t_f$	5 10 15	No Limit			—
Rise and Fall Time, Reset or $\bar{CE}$	$t_r, t_f$	5 10 15	— — —	— — —	15 5 4	$\mu\text{s}$
Removal Time, Reset to Clock or $\bar{CE}$	$t_{rem}$	5 10 15	160 80 70	80 40 35	— — —	ns

\*The formulas given are for the typical characteristics only at 25°C.

#Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.



LOGIC DIAGRAM



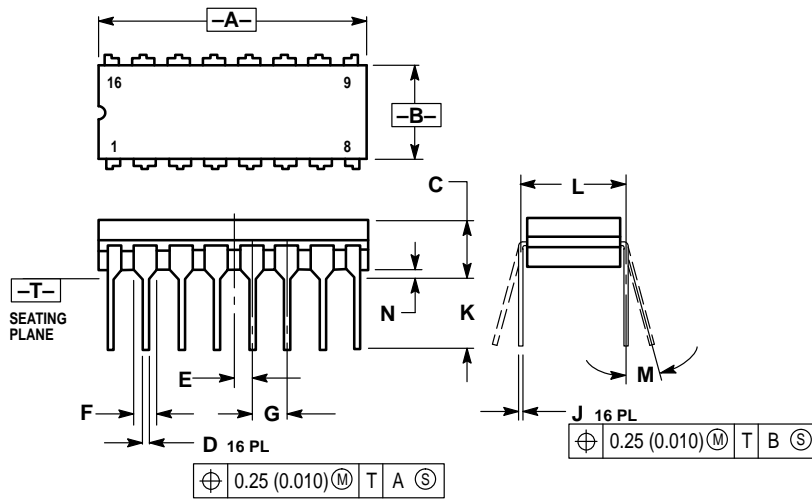
V<sub>DD</sub> = PIN 16  
V<sub>SS</sub> = PIN 8

PIN ASSIGNMENT

L2	1	16	V <sub>DD</sub>
L1	2	15	L4
RESET	3	14	L8
CLOCK	4	13	L16
CE	5	12	L32
B	6	11	Q̄
A	7	10	Q
V <sub>SS</sub>	8	9	A/B SEL

### OUTLINE DIMENSIONS

#### L SUFFIX CERAMIC DIP PACKAGE CASE 620-10 ISSUE V

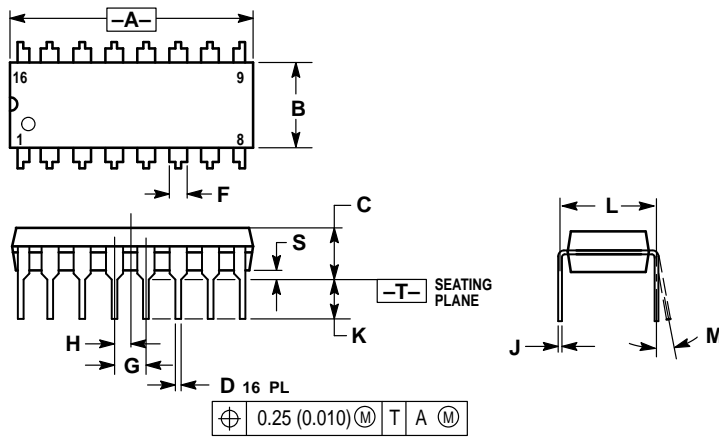


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	—	0.200	—	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

#### P SUFFIX PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

